



SMT power inductors

Size 12.3 × 12.3 × 6.0 (mm)

Series/Type: **B82477G2**

Date: **March 2008**

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SMD

Rated inductance 1 μH to 1000 μH
Rated current 0.4 A to 9 A



Construction

- Ferrite core
- Magnetically shielded
- Winding: enamel copper wire
- Winding soldered to terminals

Features

- Temperature range up to 125 °C
- High rated current
- Low DC resistance
- Suitable for lead-free reflow soldering
- Qualification based on AEC-Q200
- RoHS-compatible

Applications

- Filtering of supply voltages
- Coupling, decoupling
- DC/DC converters
- Industrial electronics
- EDP (Electronic Data Processing)
- Consumer electronics

Terminals

- Base material
Cu ($L \leq 10 \mu\text{H}$), CuSn6P ($L \geq 15 \mu\text{H}$)
- Layer composition Ni, Sn (lead-free)
- Electro-plated

Marking

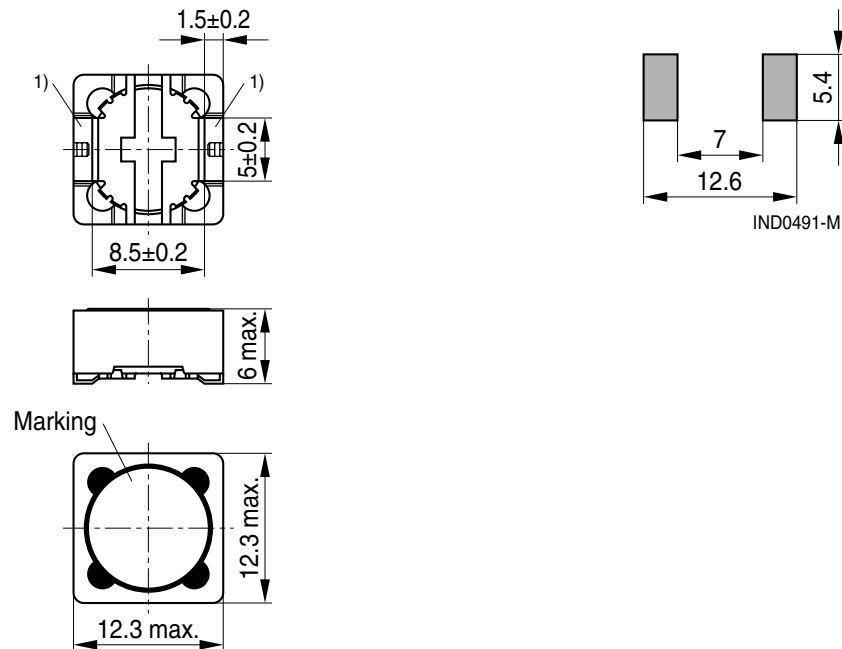
- Marking on component:
Manufacturer, L value (μH , coded),
manufacturing date (YWWDD)
- Minimum data on reel:
Manufacturer, ordering code, L value,
quantity, date of packing

Delivery mode and packing unit

- 24-mm blister tape, wound on 330-mm \varnothing reel.
- Packing unit: 600 pcs./reel

SMD

Dimensional drawing and layout recommendation



1) Soldering area

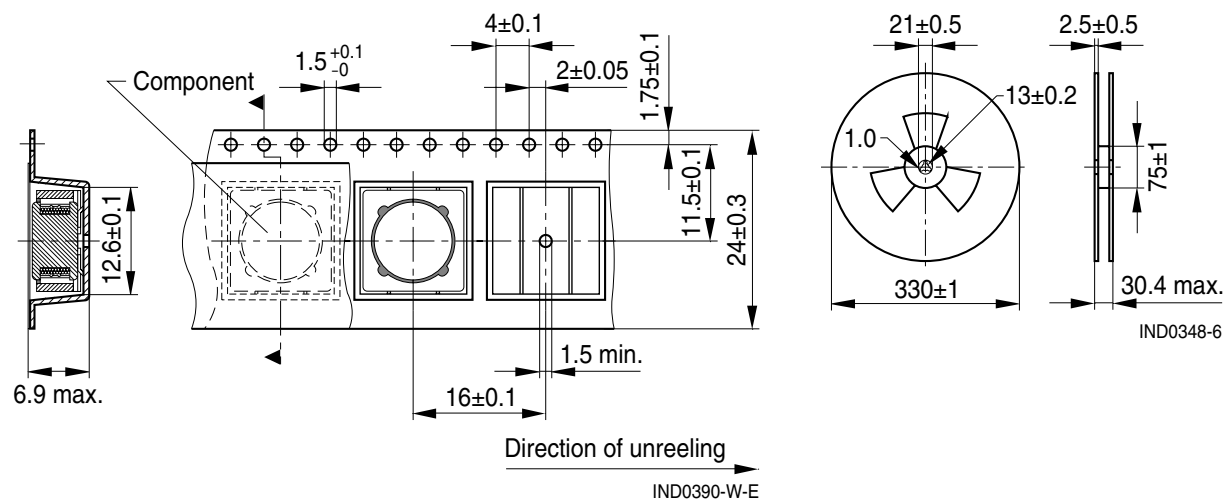
Dimensions in mm

IND0490-H-E

Taping and packing

Blister tape

Reel



Dimensions in mm

Technical data and measuring conditions

| | |
|------------------------------|--|
| Rated inductance L_R | Measured with LCR meter Agilent 4284A at frequency f_L , 0.1 V, 20 °C |
| Rated temperature T_R | 85 °C |
| Rated current I_R | Max. permissible DC with temperature increase of ≤ 40 K at rated temperature |
| DC resistance R_{max} | Measured at 20 °C |
| Solderability (lead-free) | Dip and look method Sn95.5Ag3.8Cu0.7: (245 \pm 5) °C, (5 \pm 0.3) s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58) |
| Resistance to soldering heat | 260 °C, 10 s (based on IEC 60068-2-58) |
| Climatic category | 55/125/56 (to IEC 60068-1) |
| Storage conditions | Mounted: -55 °C ... +125 °C Packaged: -25 °C ... +40 °C, $\leq 75\%$ RH |
| Weight | Approx. 4 g |

Characteristics and ordering codes

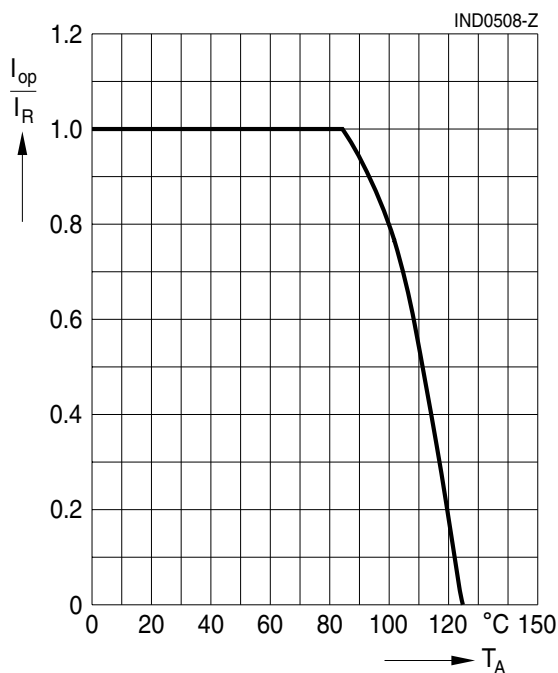
| L_R μH | Tolerance | f_L MHz | I_R A | R_{max} Ω | Ordering code |
|------------------------|-------------------------|--------------|------------|-----------------------|-----------------|
| 1.0 | $\pm 20\% \triangleq M$ | 0.001 | 9.0 | 0.009 | B82477G2102M000 |
| 1.3 | | 0.001 | 8.7 | 0.010 | B82477G2132M000 |
| 2.2 | | 0.001 | 7.0 | 0.014 | B82477G2222M000 |
| 3.3 | | 0.001 | 6.0 | 0.017 | B82477G2332M000 |
| 4.7 | | 0.001 | 5.0 | 0.020 | B82477G2472M000 |
| 6.8 | | 0.001 | 4.4 | 0.022 | B82477G2682M000 |
| 7.5 | | 0.001 | 4.2 | 0.023 | B82477G2752M000 |
| 10 | | 0.001 | 4.0 | 0.025 | B82477G2103M000 |
| 12 | | 0.001 | 3.5 | 0.027 | B82477G2123M000 |
| 15 | | 0.001 | 3.3 | 0.030 | B82477G2153M000 |
| 22 | | 0.001 | 2.8 | 0.036 | B82477G2223M000 |
| 33 | | 0.001 | 2.1 | 0.057 | B82477G2333M000 |
| 47 | | 0.001 | 1.8 | 0.075 | B82477G2473M000 |
| 68 | | 0.001 | 1.5 | 0.120 | B82477G2683M000 |
| 100 | | 0.001 | 1.3 | 0.160 | B82477G2104M000 |



Characteristics and ordering codes

| L_R μH | Tolerance | f_L MHz | I_R A | R_{max} Ω | Ordering code |
|-------------|-----------|--------------|------------|----------------|-----------------|
| 150 | ±20% Δ M | 0.001 | 1.0 | 0.23 | B82477G2154M000 |
| 220 | | 0.001 | 0.80 | 0.40 | B82477G2224M000 |
| 330 | | 0.001 | 0.68 | 0.51 | B82477G2334M000 |
| 470 | | 0.001 | 0.58 | 0.77 | B82477G2474M000 |
| 680 | | 0.001 | 0.48 | 1.20 | B82477G2684M000 |
| 1000 | | 0.001 | 0.40 | 1.53 | B82477G2105M000 |

Sample kit available. Ordering code: B8247XX001
 For more information refer to chapter "Sample kits".

**Current derating I_{op}/I_R
 versus ambient temperature T_A**
 (rated temperature $T_R = 85\text{ °C}$)


Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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